

Technical Card

FLUX VARNISH LT-4

The product protects the printed circuit boards against oxidation and corrosion during storage. This allows for faster soldering and prevents from "cold solders". The application method enables easy distribution of the product on boards. It can be used during production, repair, maintenance and service.

It meets the requirements of DIN 8511, F-SW-31, PN EN 29454 1.1.1.A.

Flux type: rosin

Flux type: RMA.

Drying time: 20 - 30 min

Application:

- protection of PCB against oxidation,
- applied in the production of printed circuit boards immediately after etching.
- prevents from contamination during assembly. it allows for easier soldering of heavily oxidized surfaces.

Physico-chemical properties:

Parameters	mu	Result
Density in temp. 20°C	g/cm ³	0,75
Viscosity	MPa·s	23,1

Packaging:

Capacity	Collective packaging	Article code
100 ml (aerosol)	4 or 20	ART.AGT-235

Warehousing

Warehouse in closed containers in a dry, well-ventilated place, away from heat and ignition sources and direct sunlight. Do not expose to temperatures exceeding 50oC/ 122oF. Protect against electrostatic discharges.

Data contained in this document are consistent with the current state of our knowledge. They describe typical properties and applications of the product. However, it is a user's responsibility to test the suitability of this product for specific applications. We are not responsible for the obtained results, due to the fact that the conditions of use are beyond our control.